

NOT RECOMMENDED FOR NEW DESIGN USE DMP2070UQ



DMP2100UQ

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on) max	Package	I _D T _A = +25°C
	38mΩ @ V _G S = -10V		-4.3A
-20V	43mΩ @ V _{GS} = -4.5V	SOT23	-4.0A
	75mΩ @ V _{GS} = -2.5V		-2.8A

Description

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Load switches
- Power management functions
- Motor controls

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES™ DMP2100UQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

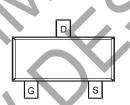
Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [©]3
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

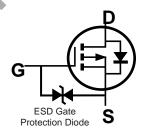








Top View
Pin Configuration



Equivalent Circuit (Note 4)

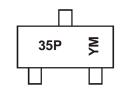
Ordering Information (Note 5)

Part Number		Package	Packing		
Part Number	X	Fackage	Qty.	Carrier	
DMP2100UQ-7		SOT23	3,000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. The ESD gate protection diode is only designed to protect against ESD events. No gate-source voltage greater than the maximum V_{GSS} rating (given on page 2) can be applied.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



35P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022) M = Month (ex: 9 = September)

Date Code Key

Year	2019		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	G		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage	n-Source Voltage		VDSS	-20	V
Gate-Source Voltage (Note 6)			V _{GSS}	±10	V
Continuous Drain Current (Note 9) V 40V	Steady State	T _A = +25°C T _A = +70°C	ID	-4.3 -3.4	А
Continuous Drain Current (Note 8) V _{GS} = -10V	t<5s	T _A = +25°C T _A = +70°C	lD	-5.5 -4.3	А
Maximum Continuous Body Diodes Forward Curre	ent (Note 8	Is	-2	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	%)	I _{DM}	-30	Α	
Pulsed Body Diodes Forward Current (10µs Pulse	, Duty Cyc	cle = 1%)	I _{SM}	-30	Α

Thermal Characteristics

Characteristic		Symbol		Value	Unit
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	PD		0.8 0.5	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State t<5s	Reja		161 96	°C/W
Total Power Dissipation (Note 8)	$T_A = +25$ °C $T_A = +70$ °C	PD	(.	1.3 0.8	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State t<5s	Reja		99 60	°C/W
Thermal Resistance, Junction to Case (Note 8)		Rejc		15	
Operating and Storage Temperature Range		TJ, TSTG		-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

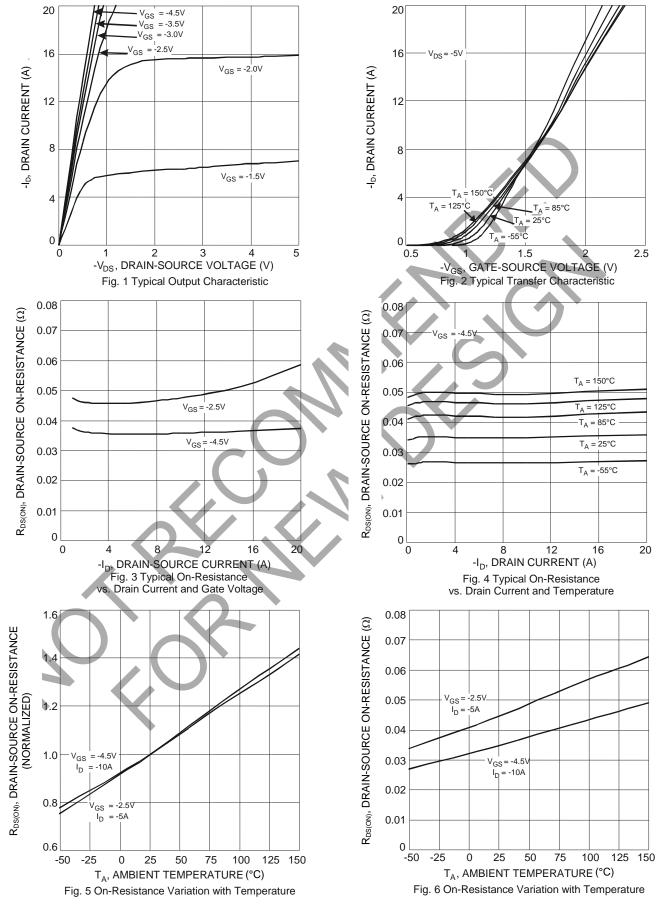
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)					•	
Drain-Source Breakdown Voltage	BVDSS	-20	7	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	7		-1	μΑ	V _{DS} = -20V, V _{GS} = 0V
Gate-Source Leakage	Igss		7 –	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V _{GS(TH)}	-0.3	_	-1.4	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			25	38		$V_{GS} = -10V, I_{D} = -3.5A$
Static Drain-Source On-Resistance	Dec.	<u> </u>	29	43	mΩ	$V_{GS} = -4.5V, I_D = -3A$
Static Drain-Source Off-Resistance	RDS(ON)	_	37	75	11122	Vgs = -2.5V, ID = -1A
		_	47	_		$V_{GS} = -1.8V, I_{D} = -0.5A$
Forward Transfer Admittance	Yfs	_	3	_	S	V _{DS} = -5V, I _D = -4A
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	216		pF	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Output Capacitance	Coss	_	90	-	pF	V _{DS} = -15V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	24		pF	1 = 1.0WI 12
Gate Resistance	Rg	_	250		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
SWITCHING CHARACTERISTICS (Note 10)						
Total Gate Charge	Q_g	_	9.1	_	nC	\\ 45\\\\ 40\\\
Gate-Source Charge	Qgs	_	1.6		nC	Vgs = -4.5V, Vps = -10V
Gate-Drain Charge	Q_{gd}	_	2.0	_	nC	1D = -4A
Turn-On Delay Time	tD(ON)	_	80	_	ns	
Turn-On Rise Time	t _R	_	155	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	_	688	_	ns	$R_D = 2.5\Omega, R_G = 3.0\Omega$
Turn-Off Fall Time	tF	_	423	_	ns	

Notes:

- 6. AEC-Q101 V_{GS} maximum is ±9.6V.
 7. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 8. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 9. Short duration pulse test used to minimize self-heating effect.

- 10. Guaranteed by design. Not subject to product testing.







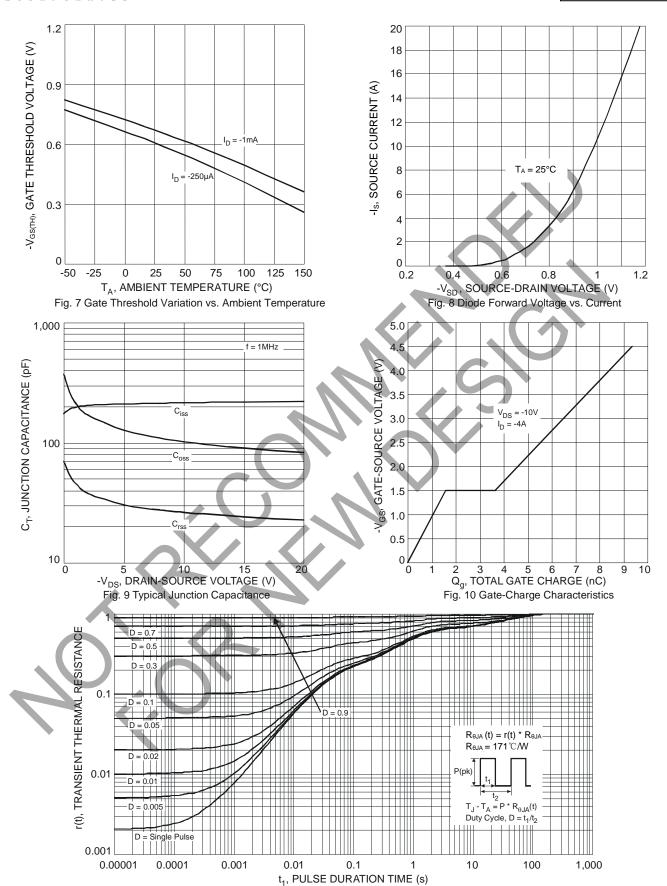


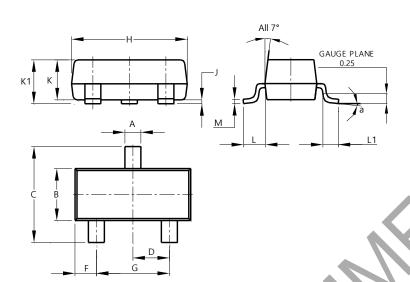
Fig. 11 Transient Thermal Response



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

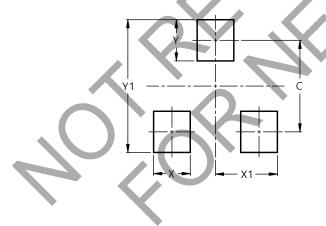


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
C	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
H	2.80	3.00	2.90				
5	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
Г	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
M	0.085	0.150	0.110				
a	0°	8°					
All	Dimens	ions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
V1	2.0



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